The 8th International Conference on Microelectronics and Plasma Technology | The 9th International Symposium on Functional Materials

Joint International Conference on The 8th ICMAP & The 9th ISFM

January 17-20, 2021 I Online Conference

| [MC2] Plasma Modeling and Simulation Techniques II | |
|--|---------------------------------------|
| Date / Time | January 18 (Mon.), 2021 / 14:10-16:00 |
| Place | Channel C |
| Session Chair(s) | De-Qi Wen (Michigan State Univ., USA) |

[MC2-1] Invited 14:10-14:40

Dynamics of Two-Dimensional Dusty Plasmas Modified by One-Dimensional Periodic Substrate Yan Feng

Soochow Univ., China

[MC2-2] 14:40-15:00

Hybrid Simulation on the Instability in Capacitively Coupled CF₄/Ar Plasmas Driven by an Asymmetric Dual Frequency Waveform

Wan Dong, Yi-Fan Zhang, Yuan-Hong Song, Zhong-Ling Dai, and You-Nian Wang *Dalian Univ. of Tech., China*

[MC2-3] 15:00-15:20

Effect of Driving Frequency on the Plasma Parameters and Electron Heating Mechanism in Very High Frequency Capacitive Discharges

Nishant Sirse¹, Sarveshwar Sharma², Miles M Turner³, and Albert R Ellingboe³

¹IPS Academy, Indore, India, ²Inst. for Plasma Research, India, ³Dublin City Univ., Ireland

[MC2-4] 15:20-15:40

Investigation of Collision Effect on Ion Incident Angle at Biased Target in Magnetized Hydrogen Plasma

Myeong-Geon Lee¹, Nam-Kyun Kim², Jamin Song¹, Ki-Baek Roh¹, and Gon-Ho Kim¹ ¹Seoul Nat'l Univ., Korea, ²Samsung Electronics Co., Ltd., Korea

[MC2-5] 15:40-16:00

Breakdown Process of Dual-Frequency Capacitively Coupled Plasma: A Collective Simulation

Hao Wu¹, Youyou Zhou², Jiamao Gao¹, Zhijiang Wang¹, Yanli Peng³, and Wei Jiang¹

¹Huazhong Univ. of Sci. and Tech., China, ²Wuhan Univ. of Tech., China, ³East China Univ. of Tech., China